

Title: Reply to TISPAN on Workshop on iIMS over Fixed Accessi

Work Item: -

Source: TSG SA

To: ETSI TISPAN

Cc: ATIS, CN, SA1, SA2, SA3, CN1, CN3, CN4,

Contact Person:

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1. Discussion

3GPP TSG SA would like to thank ETSI TISPAN for the LS (SP-040869/05TD063) that proposes a second WS on iIMS over fixed accessi. 3GPP supports the proposed WS and the preferred dates of March 30-31, 2005.

3GPP would like to ensure that the invitation is open to participants from all 3GPP OPs.

3GPP notes that even if CN1 and SA2 expert participation is requested, companies will send experts as they see appropriate.

3GPP also ask ETSI TISPAN to note that a workshop is not binding on the parent bodies; hence, agreements made at the WS will need endorsement in the parent bodies.

2. Actions:

To SA2 group.

ACTION:

3GPP requests the 3GPP TSG SA WG2 management to organise such a workshop in conjunction with ETSI TISPAN and 3GPP OPs.

To ETSI TISPAN group.

ACTION:

3GPP asks ETSI TISPAN endorse the workshop and to take note of the considerations above.

3. Dates of Next TSG SA and SA2 Meetings:

SA#27	14 th -17 th March, 2005	Tokyo, Japan
SA2#45	26 th January ñ 2 nd February, 2005	Budapest, Hungary
SA2#46	4 th ñ 8 th April, 2005	Beijing, China
SA#28	6 th -9 th June, 2005	Quebec, Canada